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Amendments to the Specification:

Please amend the paragraph beginning on page 10 at line 15 as follows:

Movable plate 52, whose free end is held upward by a spring means such as flat springs, is arranged to move the most upper paper sheet of the recording [[pager]] paper P on movable plate 52 to touch pick-up rollers 53. Recording paper sheets P, touching pick-up roller 53, is pulled from supplying paper cartridge 51 and conveyed to resistant roller 55 through plural middle rollers 54, after being individually separated by handling rollers 53A.

Please amend the paragraph beginning on page 13 at line 1 as follows:

Constant-adhesive cleaning mechanism 80, which cleans the surface of heating roller 61, is provided downstream in the rotational direction of nipping portion T, contacting the outer circumference of heating roller 61. In this constant-adhesive cleaning mechanism 80, heat-resistant non-woven fabric, with a mould-releasing agent soaked, of cleaning web 84 is spread over winding-up roller 81, back-up roller 82 and source-winding roller [[84]] 83. Cleaning mechanism 80 functions, to remove the

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residual toner and paper-powdered debris, which are adhered on the surface of heating roller 61, by pressing/contacting the cleaning web 84 onto resin-treated layer 63 of heating roller 61 aided by back-up roller 82.

Please amend the paragraph beginning at page 14, line 8 as follows:

Temperature detecting means 11 will now be explained. Fig. [[4]] 4a is a schematic diagram showing the configuration of temperature detecting means 11 and heating roller 61. This temperature detecting means 11 includes thermistor element 13 as a heat-sensitive element and flat springs 14. Resin-mould unit 15 fixes one end of flat springs 14. Projection 150 is formed at resin-mould unit 15 to limit the setting direction, and the location of the resin-mould unit 15 is set correctly by screwing it onto sensor attaching panel 16.